PATENT 81872.0028

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Shinichi KORIYAMA

Serial No: 09/996.349

Filed:

November 27, 2001

For:

Wiring Substrate, Wiring Board, and

Wiring Substrate Mounting Structure

STATUS REQUEST

Mail Stop Status Inquiry Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

This application was filed on November 27, 2001 and receipt by the U.S. Patent and Trademark Office was acknowledged in the Updated Filing Receipt dated March 8, 2002. However, no Office Action has yet been received. Accordingly, Applicants request to be advised of the status of the application, including an indication of when the patent application is expected to be examined.

Please send the undersigned a Status Report on this application.

Respectfully submitted,

HOGAN & HARTSON L.L.P

sistration No. 44,228 Attorney for Applicant(s)

Date: October 19, 2005

500 South Grand Avenue Suite 1900

Los Angeles, California 90071 Telephone: 213 337-6700

Facsimile: 213 337-6701

Art Unit: 2811

Examiner: Not Assigned

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed

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Alexandria, VA 22313-1450, on

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Sheila Goldner

10/19/05 Signature